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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or
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2SK1637, 2SK2422

Silicon N-Channel MOS FET



ADE-208-1305 (Z) 1st. Edition Mar. 2001

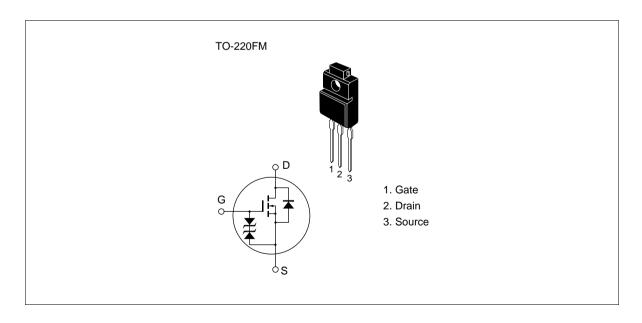
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



2SK1637, 2SK2422

Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1637	V _{DSS}	600	V
	2SK2422		650	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	4	A
Drain peak current		l _{D(pulse)} *1	16	A
Body to drain diode reverse drain current		I _{DR}	4	A
Channel dissipation		Pch*2	35	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Note 1. PW 10 µs, duty cycle 1%

2. Value at $T_c = 25$ °C

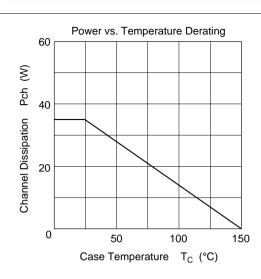
Electrical Characteristics ($Ta = 25^{\circ}C$)

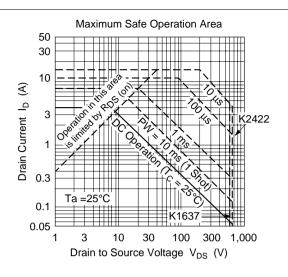
Symbol	Min	Тур	Max	Unit	Test conditions
$V_{(BR)DSS}$	600	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
_	650				
$V_{(BR)GSS}$	±30	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
I _{DSS}	_	_	250	μA	$V_{DS} = 500 \text{ V}, V_{GS} = 0$
_					$V_{DS} = 550 \text{ V}, V_{GS} = 0$
$V_{GS(off)}$	2.0	_	3.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
R _{DS(on)}	_	1.8	2.4		$I_D = 2 A, V_{GS} = 10 V^{*1}$
_	_	2.0	2.6		
yfs	2.2	3.5	_	S	$I_D = 2 A, V_{DS} = 10 V^{*1}$
Ciss	_	600	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Coss	_	140	_	pF	f = 1 MHz
Crss	_	25	_	pF	
t _{d(on)}	_	8	_	ns	$I_D = 2 A, V_{GS} = 10 V,$
t _r	_	30	_	ns	R _L = 15
t _{d(off)}	_	60	_	ns	
t _f	_	35	_	ns	_
V_{DF}	_	0.9	_	V	$I_F = 4 A, V_{GS} = 0$
t _{rr}	_	300	_	ns	$I_F = 4 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$
	$\begin{array}{c} V_{(BR)DSS} \\ \\ V_{(BR)GSS} \\ \\ I_{GSS} \\ \\ I_{DSS} \\ \\ V_{GS(off)} \\ \\ R_{DS(on)} \\ \\ \\ I_{DS} \\ \\ \\ V_{GS(off)} \\ \\ I_{DS} \\ \\$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

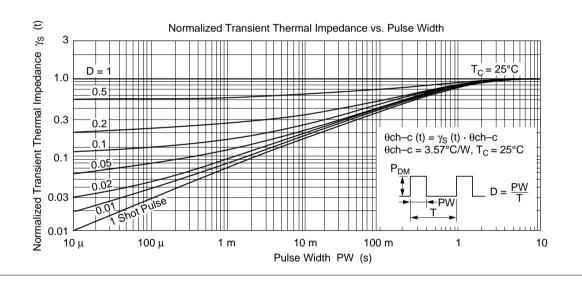
Note 1. Pulse test

See characteristics curves of 2SK1402, 2SK1402A.

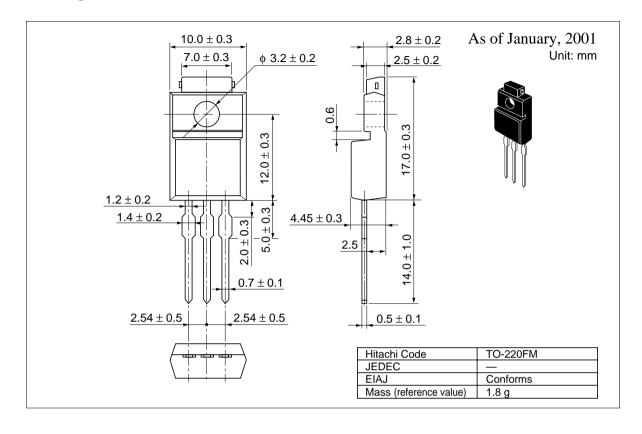
2SK1637, 2SK2422







Package Dimensions



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